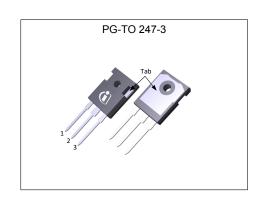


MOSFET

650V CoolMOS™ CFD7 SJ Power Device

The latest 650 V CoolMOS™ CFD7 extends the voltage class offering of the CFD7 family and is a successor to the 650 V CoolMOS™ CFD2. Resulting from improved switching performance and excellent thermal behavior, 650 V CooMOS™ CFD7 offers highest efficiency in resonant switching topologies, such as LLC and phase-shift-full-bridge (ZVS). As part of Infineon's fast body diode portfolio, this new product series blends all advantages of a fast switching technology together with superior hard commutation robustness. The CoolMOS™ CFD7 technology meets highest efficiency and reliability standards and furthermore supports high power density solutions.



Features

- · Ultra-fast body diode
- 650V break down voltage
- Best-in-class R_{DS(on)}
- Reduced switching losses
- Low R_{DS(on)} dependency over temperature

Benefits

- Excellent hard commutation ruggedness
- · Extra safety margin for designs with increased bus voltage
- Enabling increased power density solutions
- Outstanding light load efficiency in industrial SMPS applications
- Improved full load efficiency in industrial SMPS applications
- Price competitiveness over previous CoolMOS™ families

Potential applications

Suitable for Soft Switching topologies Optimized for phase-shift full-bridge (ZVS), LLC Applications – Server, Telecom, EV Charging, Solar



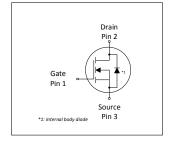
Fully qualified according to JEDEC for Industrial Applications

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.



Talloto T Troy T Office Tollows							
Parameter	Value	Unit					
V _{DS} @ T _{j,max}	700	V					
R _{DS(on),max}	29	mΩ					
$Q_{g,typ}$	145	nC					
I _{D,pulse}	304	A					
E _{oss} @ 400V	19.8	μJ					
Body diode di _F /dt	1300	A/µs					

Type / Ordering Code	Package	Marking	Related Links
IPW65R029CFD7	PG-TO247-3	65R029F7	see Appendix A









650V CoolMOS™ CFD7 SJ Power Device IPW65R029CFD7



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650V CoolMOS™ CFD7 SJ Power Device IPW65R029CFD7



1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	Ol		Value	S	11!4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	-	-	69 44	А	T _C =25°C T _C =100°C
Pulsed drain current ²⁾	I _{D,pulse}	-	-	304	Α	T _C =25°C
Avalanche energy, single pulse	E AS	-	-	358	mJ	I_D =7.3A; V_{DD} =50V; see table 10
Avalanche energy, repetitive	E AR	-	-	1.79	mJ	I _D =7.3A; V _{DD} =50V; see table 10
Avalanche current, single pulse	I _{AS}	-	-	7.3	Α	-
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V _{DS} =0400V
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)
Power dissipation	P _{tot}	-	-	305	W	<i>T</i> _C =25°C
Storage temperature	$T_{ m stg}$	-55	-	150	°C	-
Operating junction temperature	T _j	-55	-	150	°C	-
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws
Continuous diode forward current ¹⁾	Is	-	-	69	Α	<i>T</i> _C =25°C
Diode pulse current ²⁾	I _{S,pulse}	-	-	304	Α	<i>T</i> _C =25°C
Reverse diode dv/dt ³⁾	dv/dt	-	-	70	V/ns	V _{DS} =0400V, I _{SD} <=35.8A, T _j =25°C see table 8
Maximum diode commutation speed	di _F /dt	-	-	1300	A/μs	V _{DS} =0400V, I _{SD} <=35.8A, T _j =25°C see table 8
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	V _{rms} , T _C =25°C, t=1min

 $^{^{1)}}$ Limited by $T_{j\,\text{max}}.$ $^{2)}$ Pulse width t_p limited by $T_{j,\text{max}}$ $^{3)}$ Identical low side and high side switch with identical R_G

650V CoolMOS™ CFD7 SJ Power Device IPW65R029CFD7



2 Thermal characteristics

Table 3 Thermal characteristics

Davamatav	Symbol	Values			I Imit	Nata / Tast Candition
Parameter	Symbol	Min. Typ. Max.		Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	0.41	°C/W	-
Thermal resistance, junction - ambient		-	-	62	°C/W	leaded
Thermal resistance, junction - ambient for SMD version	R _{thJA}	-	-	-	°C/W	n.a.
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s

650V CoolMOS™ CFD7 SJ Power Device IPW65R029CFD7



Electrical characteristics

at T_j=25°C, unless otherwise specified

Table 4 **Static characteristics**

Parameter.	Oh o.l		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	650	-	-	V	V_{GS} =0V, I_D =1mA
Gate threshold voltage	V _{(GS)th}	3.5	4	4.5	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=1.79{\rm mA}$
Zero gate voltage drain current ¹⁾	I _{DSS}	-	- 27	1 54	μΑ	V _{DS} =650V, V _{GS} =0V, T _j =25°C V _{DS} =650V, V _{GS} =0V, T _j =125°C
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.024 0.053	0.029	Ω	V _{GS} =10V, I _D =35.8A, T _j =25°C V _{GS} =10V, I _D =35.8A, T _j =150°C
Gate resistance	R _G	-	3.8	-	Ω	f=1MHz, open drain

Dynamic characteristics Table 5

Doromotor	C: mah al		Values			Nata (Tant Oan didina	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	C _{iss}	-	7149	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Output capacitance	Coss	_	106	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz	
Effective output capacitance, energy related ²⁾	C _{o(er)}	-	247	-	pF	V _{GS} =0V, V _{DS} =0400V	
Effective output capacitance, time related ³⁾	C _{o(tr)}	-	2584	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0400V	
Turn-on delay time	$t_{ m d(on)}$	-	54	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8 Ω ; see table 9	
Rise time	t _r	-	13	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8 Ω ; see table 9	
Turn-off delay time	$t_{ m d(off)}$	-	159	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8 Ω ; see table 9	
Fall time	t _f	-	3	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8 Ω ; see table 9	

Table 6 **Gate charge characteristics**

Davamatav	C: mah al		Values			Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	41	-	nC	V_{DD} =400V, I_{D} =35.8A, V_{GS} =0 to 10V
Gate to drain charge	Q_{gd}	-	44	-	nC	V_{DD} =400V, I_{D} =35.8A, V_{GS} =0 to 10V
Gate charge total	Qg	-	145	-	nC	V_{DD} =400V, I_{D} =35.8A, V_{GS} =0 to 10V
Gate plateau voltage	V _{plateau}	_	5.7	-	V	V_{DD} =400V, I_{D} =35.8A, V_{GS} =0 to 10V

 $^{^{1)}}$ Maximum specification is defined by calculated six sigma upper confidence bound $^{2)}$ $C_{\rm o(er)}$ is a fixed capacitance that gives the same stored energy as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V $^{3)}$ $C_{\rm o(tr)}$ is a fixed capacitance that gives the same charging time as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V

650V CoolMOS™ CFD7 SJ Power Device

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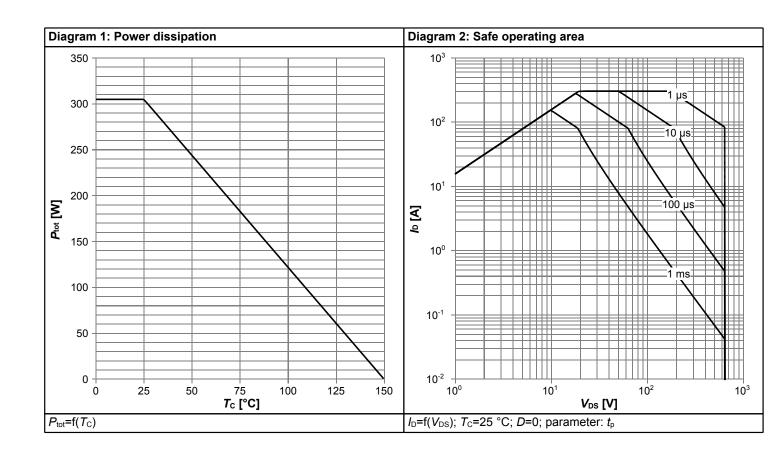


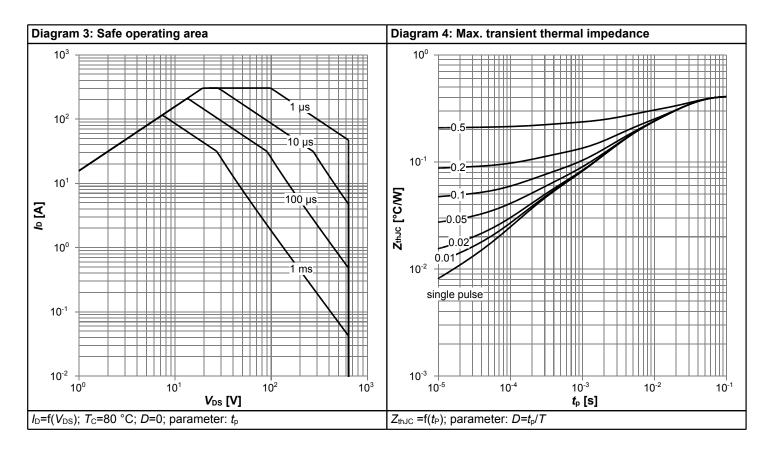
Table 7 Reverse diode characteristics

Dougnatou	Cymphal	Values			11	Nata / Tant Can dition
Parameter	Symbol Min. Typ. Max.	Unit	Note / Test Condition			
Diode forward voltage	V _{SD}	-	1.0	-	V	V _{GS} =0V, I _F =35.8A, T _j =25°C
Reverse recovery time	t _{rr}	-	208	312	ns	V_R =400V, I_F =35.8A, di_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Q _{rr}	-	1.6	3.2	μC	V_R =400V, I_F =35.8A, di_F/dt =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	-	13.1	_	А	V_R =400V, I_F =35.8A, di_F/dt =100A/ μ s; see table 8

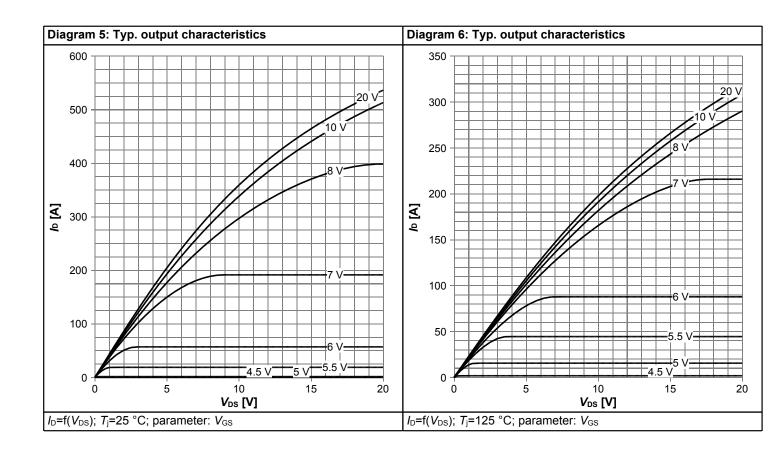


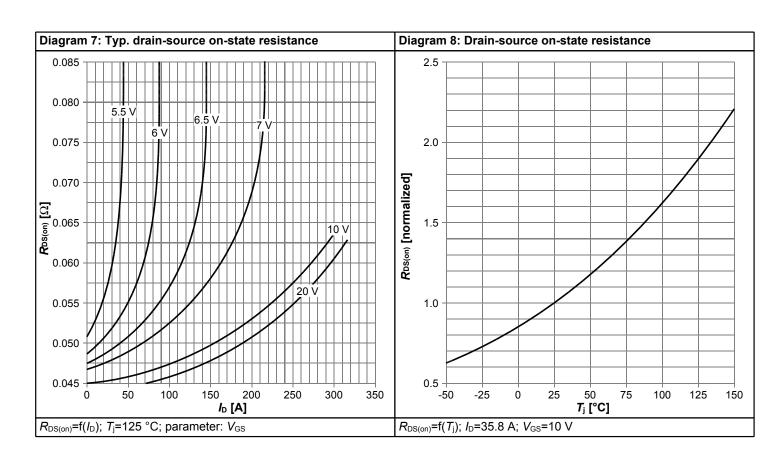
4 Electrical characteristics diagrams



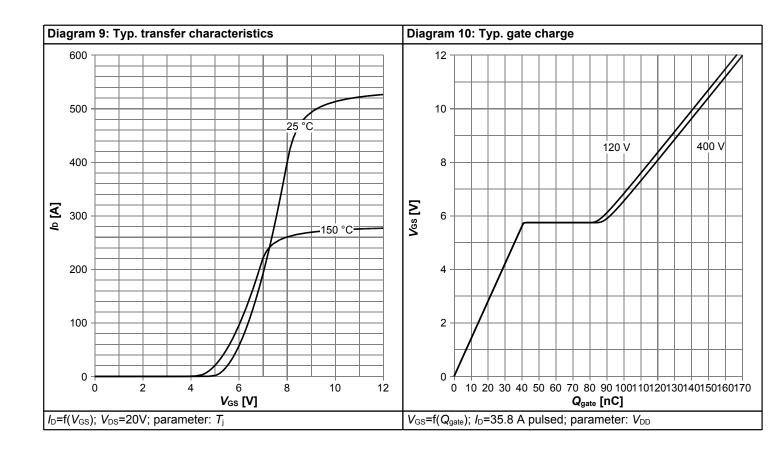


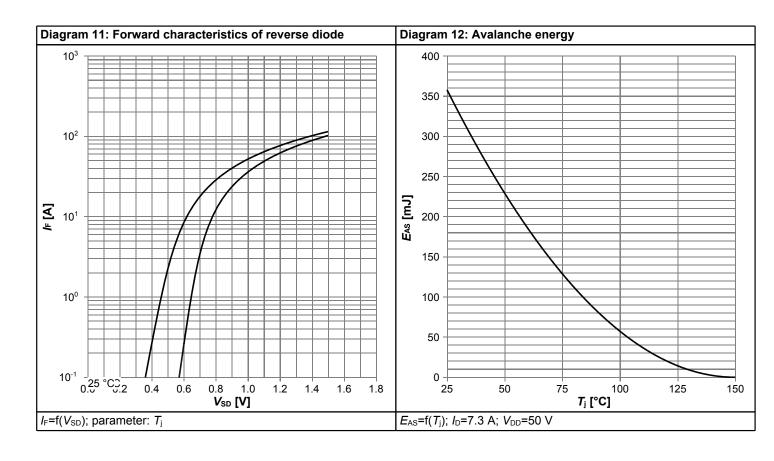




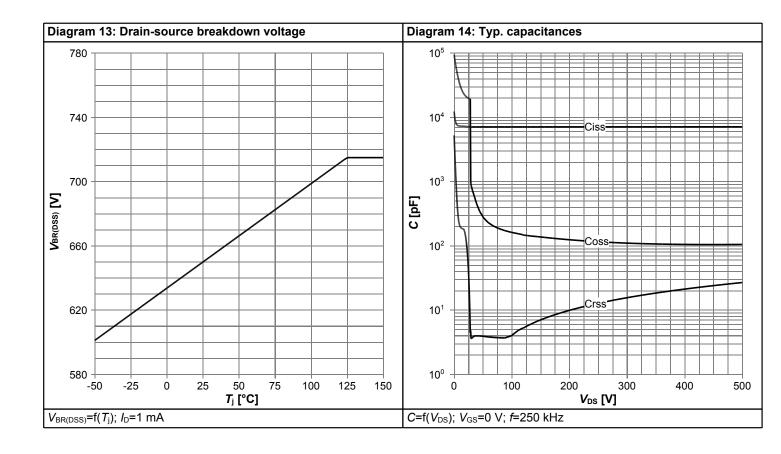


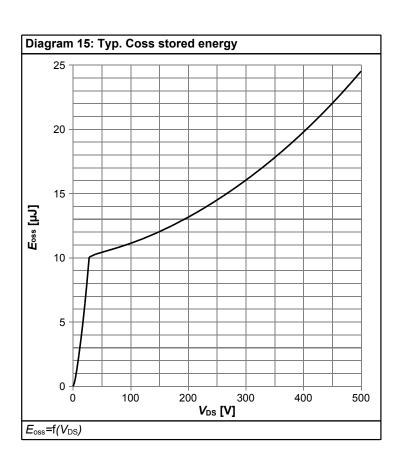














5 Test Circuits

Table 8 Diode characteristics

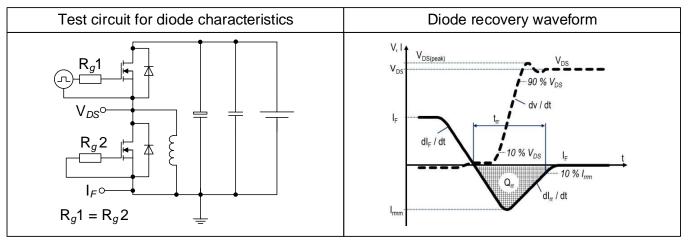


Table 9 Switching times

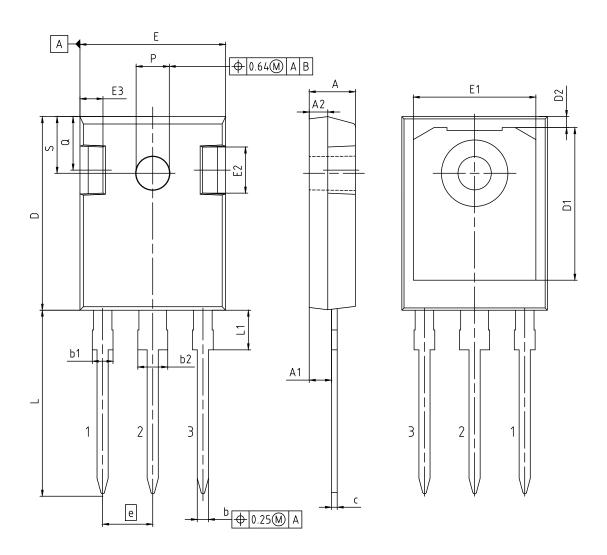


Table 10 Unclamped inductive load





6 Package Outlines



DIMENSIONS	MILLIM	ETERS	
DIMENSIONS	MIN.	MAX.	
Α	4.70	5.30	
A1	2.20	2.60	
A2	1.50	2.50	
b	1.00	1.40	
b1	1.60	2.41	DOCUMENT NO.
b2	2.57	3.43	Z8B00003327
С	0.38	0.89	REVISION
D	20.70	21.50	06
D1	13.08	17.65	
D2	0.51	1.35	SCALE 3:1
E	15.50	16.30	0 1 2 3 4 5mm
E1	12.38	14.15	
E2	3.40	5.10	
E3	1.00	2.60	EUROPEAN PROJECTION
е	5.	44	
L	19.80	20.40	
L1	3.85	4.50	
P	3.50	3.70]├───
Q	5.35	6.25	ISSUE DATE
S	6.04	6.30	25.07.2018

Figure 1 Outline PG-TO247-3, dimensions in mm

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7 Appendix A

Table 11 Related Links

• IFX CoolMOS CFD7 650V Webpage: www.infineon.com

• IFX CoolMOS CFD7 650V application note: www.infineon.com

• IFX CoolMOS CFD7 650V simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

650V CoolMOS™ CFD7 SJ Power Device

IPW65R029CFD7



Revision History

IPW65R029CFD7

Revision: 2020-07-31, Rev. 2.1

Previous	Davision
Previous	Revision

To the death to the left							
Revision	Date	Subjects (major changes since last revision)					
2.0	2020-06-19	Release of final version					
2.1	2020-07-31	Increased continuous diode forward current rating					

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Final Data Sheet 14 Rev. 2.1, 2020-07-31